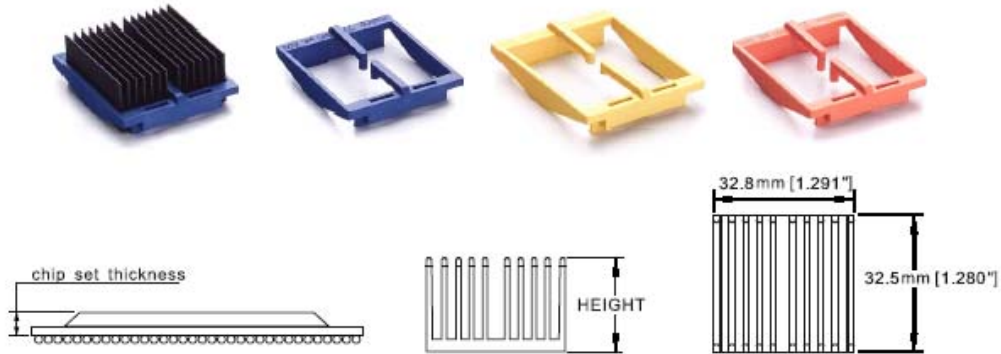


Specification BGA Heat Sink for 33x33 chip set



<ul style="list-style-type: none"> ■ Heat sink material : AL6063 ■ Finish : Black Anodize ■ Chip set package thickness and clip color : 2.1mm~2.6mm ----- Yellow clip 1.5mm~2.0mm ----- Blue clip 0.9mm~1.4mm ----- Orange clip ■ Accessory : Clip material ----- Plastic(94V0) Thermal pad ----- T725 31x31mm [1.220"] 	Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
	CMS313333-06-01	32.8 [1.291"]	32.7 [1.287"]	6.3 [0.248"]	1.7 [0.066"]	Yellow
	CMS313333-06-02					Blue
	CMS313333-06-03					Orange
	CMS313333-10-01	32.8 [1.291"]	32.5 [1.280"]	9.5 [0.374"]	1.7 [0.066"]	Yellow
	CMS313333-10-02					Blue
	CMS313333-10-03					Orange
	CMS313333-13-01	32.8 [1.291"]	32.5 [1.280"]	12.7 [0.500"]	1.7 [0.066"]	Yellow
	CMS313333-13-02					Blue
	CMS313333-13-03					Orange

Performance Heat Source(LxW):15x15mm

